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FDPF5N50FT N-Channel UniFETTM FRFET[®] MOSFET 500 V, 4.5 A, 1.55 Ω

Features

- $R_{DS(on)}$ = 1.25 Ω (Typ.) @ V_{GS} = 10 V, I_D = 2.25 A
- Low Gate Charge (Typ. 11 nC)
- Low C_{rss} (Typ. 5 pF)
- 100% Avalanche Tested

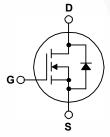
Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. The body diode's reverse recovery performance of UniFET FRFET[®] MOSFET has been enhanced by lifetime control. Its trr is less than 100nsec and the reverse dv/ dt immunity is 15V/ns while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore, it can remove additional component and improve system reliability in certain applications in which the performance of MOSFET's body diode is significant. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FDPF5N50FT	Unit
V _{DSS}	Drain to Source Voltage		500	V	
V _{GSS}	Gate to Source Voltage		±30	V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		4.5*	
		- Continuous (T _C = 100 ^o C)		2.7*	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	18*	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	233	mJ
I _{AR}	Avalanche Current (Note 1)		(Note 1)	4.5	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		(Note 1)	8.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	4.5	V/ns
P _D	Dewer Dissingtion	$(T_{C} = 25^{\circ}C)$		28	W
	Power Dissipation	- Derate Above 25 ^o C		0.22	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperat	ure for Soldering, 1/8" from Case for 5	Seconds	300	°C

*Drain current limited by maximum junction temperature

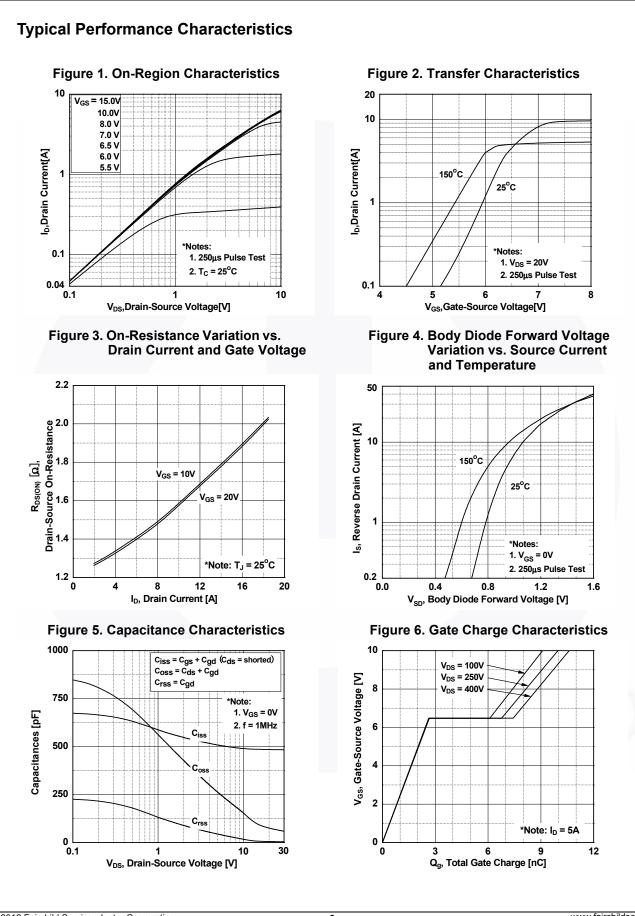
Thermal Characteristics

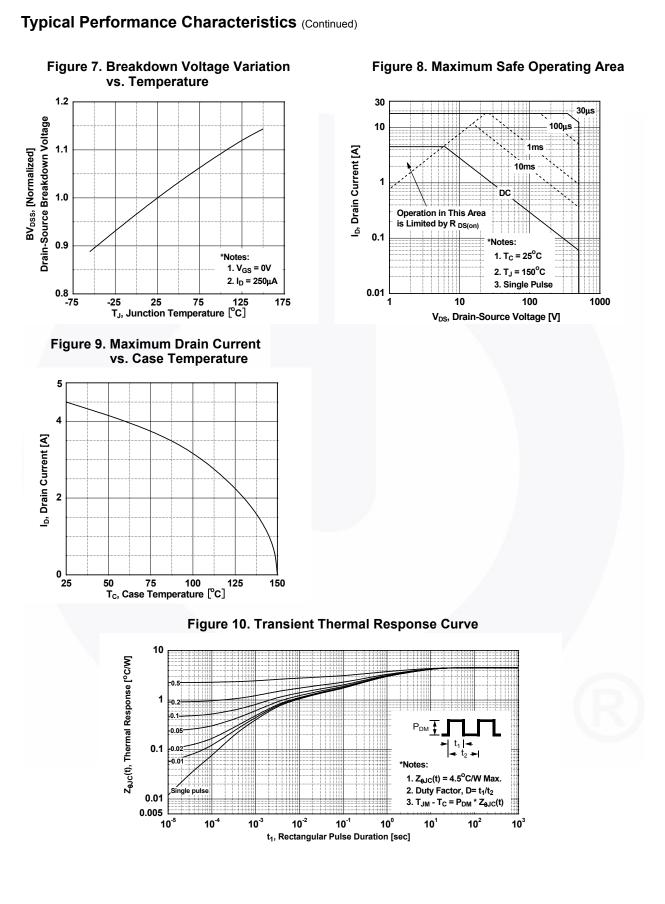
Symbol	Parameter	FDPF5N50FT	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	4.5	°C/W
R_{\thetaJA}	hermal Resistance, Junction to Ambient, Max. 62.5		C/W

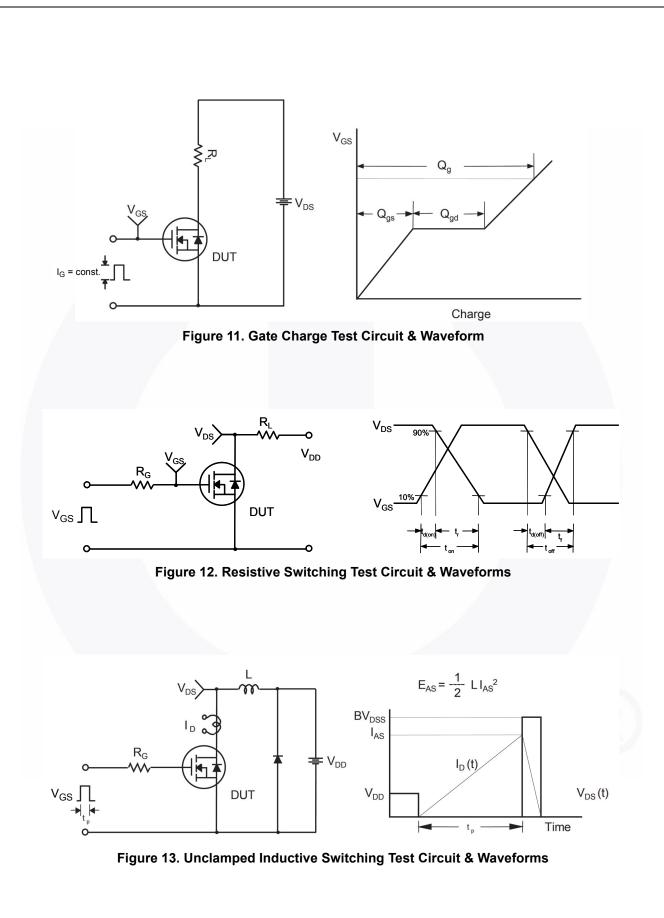
November 2013

		Package TO-220F	<u> </u>		e Tape Width		Quantity 50 units	
l Chara	cteristics T _C = 25°C	unless othe	rwise noted.					
	Parameter		Test Conditions		Min.	Тур.	Max.	Unit
teristics								
	Source Breakdown Voltage	la =	$250 \mu A V_{ab} = 0 V T$	$= 25^{\circ}$ C	500		_	V
Breakdown Voltage Temperature					-	0.6	_	V/°C
Coefficier	Coefficient						10	
Zero Gate	e Voltage Drain Current							μA
-			-					
Gale to B	ody Leakage Current	VGS	$= \pm 30$ V, V _{DS} = 0 V		-	-	±100	nA
teristics								
Gate Thre	eshold Voltage	Ves	e = Vps. Ip = 250 μA		3.0	-	5.0	V
	°				-	1.25	1.55	Ω
					-	4.3	-	S
h a ra at a r	inting							
						400	650	рЕ
		V _{DS}	; = 25 V, V _{GS} = 0 V,	-				pF
	•		f = 1 MHz		-			pF pF
					-	-		nC
	-	Vng	$V_{D0} = 400 V_{D0} = 5 A$		-			nC
	0			_	_	_		
Gale to D	rain miller Charge			(Note 4)	-	5	-	nC
Characte	eristics							
Turn-On [Delay Time				-	13	36	ns
Turn-On F	Rise Time				-	22	54	ns
Turn-Off	Delay Time	V _{GS}	$V_{\rm GS}$ = 10 V, R _G = 25 Ω		-	28	66	ns
Turn-Off F	all Time			(Note 4)	-	20	50	ns
rce Diode	Characteristics							
1		Diode For				_	45	Α
					-	-	18	A
	ource Diode Forward Voltage		= 0 V, I _{SD} = 4.5 A			-	1.5	V
	Recovery Time				-	65	-	ns
Reverse F			V _{GS} = 0 V, I _{SD} = 5 A, dI _F /dt = 100 A/μs					
	teristics Drain to S Breakdow Coefficier Zero Gate Gate to B teristics Gate Thri Static Dra Forward T haracter Input Cap Output Ca Output Ca Output Ca Gate to D Character Total Gate Gate to D Character Turn-On I Turn-Off I Turn-Off I Turn-Off I	Parameter teristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Body Leakage Current teristics Gate Threshold Voltage Static Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Total Gate Charge at 10V Gate to Drain "Miller" Charge Characteristics Turn-On Delay Time Turn-Off Delay Time Turn-Off Fall Time ce Diode Characteristics Maximum Continuous Drain to Source	Parameter teristics Drain to Source Breakdown Voltage ID = Breakdown Voltage Temperature Coefficient ID = Zero Gate Voltage Drain Current VDS VDS Gate to Body Leakage Current VGS teristics VGS Gate Threshold Voltage VGS Static Drain to Source On Resistance VGS Forward Transconductance VDS Maracteristics VDS Input Capacitance VDS Output Capacitance VDS Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller" Charge VGS Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time VGS Turn-Off Fall Time VGS Maximum Continuous Drain to Source Diode For	teristicsDrain to Source Breakdown Voltage $I_D = 250 \ \mu$ A, $V_{GS} = 0 \ V$, TBreakdown Voltage Temperature Coefficient $I_D = 250 \ \mu$ A, Referenced for $I_D = 250 \ \mu$ A, Referenced for $V_{DS} = 500 \ V$, $V_{GS} = 0 \ V$ Zero Gate Voltage Drain Current $V_{DS} = 500 \ V$, $V_{GS} = 0 \ V$ Gate to Body Leakage Current $V_{GS} = 400 \ V$, $T_C = 125^{\circ}C$ Gate to Body Leakage Current $V_{GS} = \pm 30 \ V$, $V_{DS} = 0 \ V$ teristicsGate Threshold Voltage $V_{GS} = 10 \ V$, $I_D = 2.25 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 2.25 \ A$ Forward Transconductance $V_{DS} = 20 \ V$, $I_D = 2.25 \ A$ Input Capacitance $V_{DS} = 25 \ V$, $V_{GS} = 0 \ V$, f = 1 MHzInput Capacitance $V_{DS} = 400 \ V$, $I_D = 5 \ A$, $V_{GS} = 10 \ V$ Gate to Drain "Miller" Charge $V_{DS} = 400 \ V$, $I_D = 5 \ A$, $V_{GS} = 10 \ V$ CharacteristicsTurn-On Delay Time Turn-On Rise TimeTurn-Off Delay Time $V_{DS} = 10 \ V$, $R_G = 25 \ \Omega$ Turn-Off Fall Time $V_{GS} = 10 \ V$, $R_G = 25 \ \Omega$	ParameterTest ConditionsteristicsDrain to Source Breakdown Voltage $I_D = 250 \ \mu$ A, $V_{GS} = 0 \ V$, $T_J = 25^{\circ}C$ Breakdown Voltage Temperature Coefficient $I_D = 250 \ \mu$ A, Referenced to $25^{\circ}C$ Zero Gate Voltage Drain Current $V_{DS} = 500 \ V$, $V_{GS} = 0 \ V$ Gate to Body Leakage Current $V_{GS} = \pm 30 \ V$, $V_{DS} = 0 \ V$ teristics $V_{GS} = \pm 30 \ V$, $V_{DS} = 0 \ V$ Gate Threshold Voltage $V_{GS} = 10 \ V$, $I_D = 2.25 \ A$ Static Drain to Source On Resistance $V_{GS} = 10 \ V$, $I_D = 2.25 \ A$ Forward Transconductance $V_{DS} = 20 \ V$, $I_D = 2.25 \ A$ Input Capacitance $V_{DS} = 25 \ 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Leakage Current $V_{GS} = 400 \ V, \ T_C = 125^{\circ}C$ -Gate to Body Leakage Current $V_{GS} = V_{DS}, \ I_D = 250 \ \mu$ A3.0Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 2.25 \ A$ -Forward Transconductance $V_{DS} = 20 \ V, \ I_D = 2.25 \ A$ -haracteristicsInput Capacitance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \ -$ -Reverse Transfer Capacitance $f = 1 \ MHz$ -Total Gate Charge at 10V $V_{DS} = 400 \ V, \ I_D = 5 \ A, \ V_{GS} = 10 \ V, \ Q_S = 10 \ V, \ Q$	ParameterTest ConditionsMin.Typ.teristicsDrain to Source Breakdown Voltage $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V, \ T_J = 25^{\circ}C$ 500-Breakdown Voltage Temperature Coefficient $I_D = 250 \ \mu A, \ Referenced to 25^{\circ}C$ -0.6Zero Gate Voltage Drain Current $V_{DS} = 500 \ V, \ V_{GS} = 0 \ V$ Gate to Body Leakage Current $V_{GS} = 400 \ V, \ T_C = 125^{\circ}C$ Gate to Body Leakage Current $V_{GS} = x_{DS}, \ I_D = 250 \ \mu A$ 3.0-teristicsGate Threshold Voltage $V_{GS} = V_{DS}, \ I_D = 250 \ \mu A$ 3.0-Static Drain to Source On Resistance $V_{GS} = 10 \ V, \ I_D = 2.25 \ A$ -4.3haracteristicsInput Capacitance $V_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \490Output CapacitanceV_{DS} = 25 \ V, \ V_{GS} = 0 \ V, \5Total Gate Charge at 10VV_{DS} = 400 \ V, \ I_D = 5 \ A, \ V_{GS} = 10 \ V, \ V_{CS} = 10 \ V, \ V_{C$	$\begin{tabular}{ c c c c } \hline Parameter & Test Conditions & Min. Typ. Max. \\ \hline teristics \\ \hline Drain to Source Breakdown Voltage $$ I_D = 250 \ \mu A, V_{GS} = 0 \ V, T_J = 25^\circ C $$ 500 $$ - $$ - $$ - $$ I_D $$ Breakdown Voltage Temperature $$ I_D = 250 \ \mu A, Referenced to 25^\circ C $$ - $$ 0.6 $$ - $$ - $$ 0.6 $$ - $$ - $$ 0.6 $$ - $$ - $$ 10 $$ V_{DS} = 400 \ V, T_G = 125^\circ C $$ - $$ - $$ 100 $$ V_{DS} = 400 \ V, T_G = 125^\circ C $$ - $$ - $$ 100 $$ data to Body Leakage Current $$ V_{GS} = ±30 \ V, V_{DS} = 0 \ V $$ - $$ - $$ 100 $$ teristics $$ - $$ - $$ - $$ 100 $$ teristics $$ - $$ - $$ - $$ 100 $$ teristics $$ - $$ - $$ - $$ - $$ 100 $$ teristics $$ - $$ - $$ - $$ - $$ - $$ - $$ - $$$

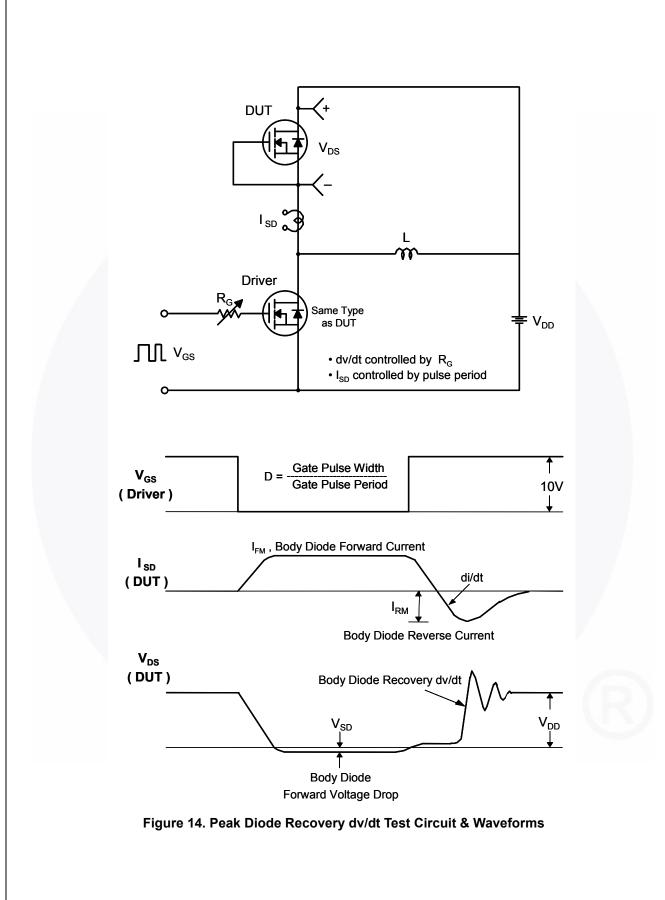


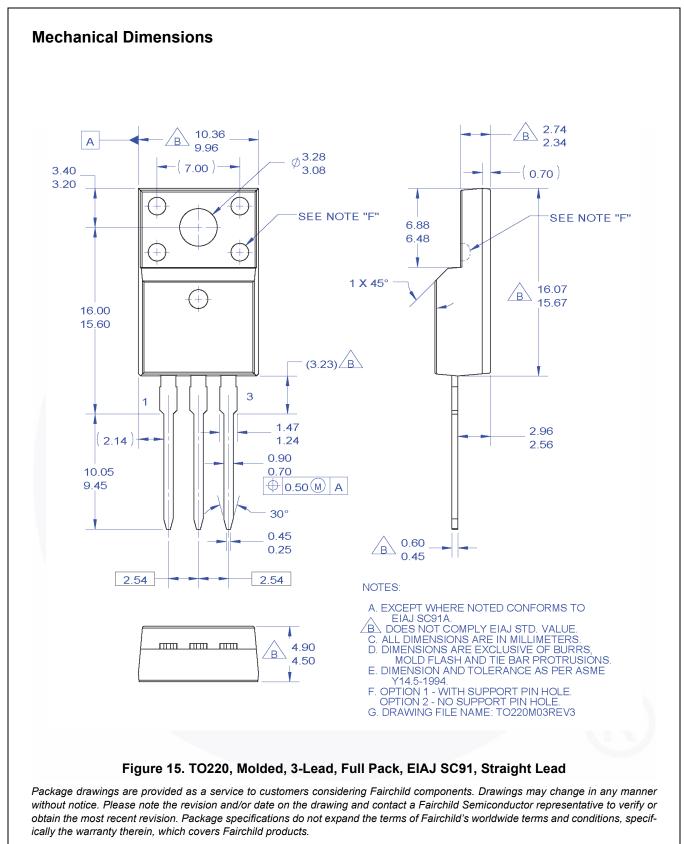






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